



SOLID STATE INC.

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Power Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

- Extremely Low v_f
- Low Power Loss/High Efficiency
- Low Stored Charge, Majority Carrier Conduction
- High Surge Capacity

Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 45.6 grams (approximately)
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires.
- Stud Torque: 15 lb-in max
- Shipped 25 units per rail
- Marking: 1N5826, 1N5827, 1N5828

1N5826
1N5827
1N5828

**SCHOTTKY BARRIER
RECTIFIERS
15 AMPERES
20, 30, 40 VOLTS**



**DO-203AA
METAL**

MAXIMUM RATINGS

Rating	Symbol	1N5826	1N5827	1N5828	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	30	40	Volts
Non-Repetitive Peak Reverse Voltage	V_{RSM}	24	36	48	Volts
Average Rectified Forward Current $V_{R(equiv)} \leq 0.2 V_{R(dc)}$, $T_C = 85^\circ C$	I_O	15			Amp
Ambient Temperature Rated $V_R(dc)$, $P_F(AV) = 0$, $R_{\theta JA} = 5.0^\circ C/W$	T_A	95	90	85	$^\circ C$
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	500 (for one cycle)			Amp
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	T_J , T_{stg}	- 65 to +125			$^\circ C$
Peak Operating Junction Temperature (Forward Current applied)	$T_{J(pk)}$	150			$^\circ C$

*THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.5	$^\circ C/W$

* Indicates JEDEC Registered Data

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

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*ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	1N5826	1N5827	1N5828	Unit
Maximum Instantaneous Forward Voltage (1) ($I_F = 8.0$ Amps) ($I_F = 15$ Amps) ($I_F = 47.1$ Amps)	V_F	0.380 0.440 0.670	0.400 0.470 0.770	0.420 0.500 0.870	Volts
Maximum Instantaneous Reverse Current @ Rated dc Voltage (1) $T_C = 100^\circ\text{C}$	I_R	10 75	10 75	10 75	mA

* Indicates JEDEC Registered Data

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

NOTE 1 — DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above $0.2 V_{RWM}$. Proper derating may be accomplished by use of equation (1):

$$T_{A(max)} = T_{J(max)} - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} \quad (1)$$

where $T_{A(max)}$ = Maximum allowable ambient temperature
 $T_{J(max)}$ = Maximum allowable junction temperature
 (125°C or the temperature at which thermal runaway occurs, whichever is lowest)
 $P_{F(AV)}$ = Average forward power dissipation
 $P_{R(AV)}$ = Average reverse power dissipation
 $R_{\theta JA}$ = Junction-to-ambient thermal resistance

Figures 1, 2, and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2):

$$T_R = T_{J(max)} - R_{\theta JA} P_{R(AV)} \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_R - R_{\theta JA} P_{F(AV)} \quad (3)$$

Inspection of equations (2) and (3) reveals that T_R is the ambient temperature at which thermal runaway occurs or where $T_J = 125^\circ\text{C}$, when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2, and 3 as a

difference in the rate of change of the slope in the vicinity of 115°C . The data of Figures 1, 2, and 3 is based upon dc conditions. For use in common rectifier circuits, Table 1 indicates suggested factors for an equivalent dc voltage to use for conservative design, i.e.:

$$V_{R(equiv)} = V_{in(PK)} \times F \quad (4)$$

The Factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

EXAMPLE: Find $T_{A(max)}$ for 1N5828 operated in a 12-volt dc supply using a bridge circuit with capacitive filter such that $I_{DC} = 10$ A ($I_{F(AV)} = 5$ A), $I_{(PK)}/I_{(AV)} = 20$, Input Voltage = 10 V(rms), $R_{\theta JA} = 5^\circ\text{C/W}$.

Step 1. Find $V_{R(equiv)}$. Read $F = 0.65$ from Table 1,
 $\therefore V_{R(equiv)} = (1.41)(10)(0.65) = 9.18$ V.

Step 2. Find T_R from Figure 3. Read $T_R = 121^\circ\text{C}$
 @ $V_R = 9.18$ V and $R_{\theta JA} = 5^\circ\text{C/W}$.

Step 3. Find $P_{F(AV)}$ from Figure 4. **Read $P_{F(AV)} = 10$ W
 @ $\frac{I_{(PK)}}{I_{(AV)}} = 20$ and $I_{F(AV)} = 5$ A

Step 4. Find $T_{A(max)}$ from equation (3).
 $T_{A(max)} = 121 - (5)(10) = 71^\circ\text{C}$.

**Values given are for the 1N5828. Power is slightly lower for the other units because of their lower forward voltage.

Table 1. Values for Factor F

Circuit	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped*†	
	Resistive	Capacitive*	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

*Note that $V_{R(PK)} \approx 2.0 V_{in(PK)}$. *†Use line to center tap voltage for V_{in} .

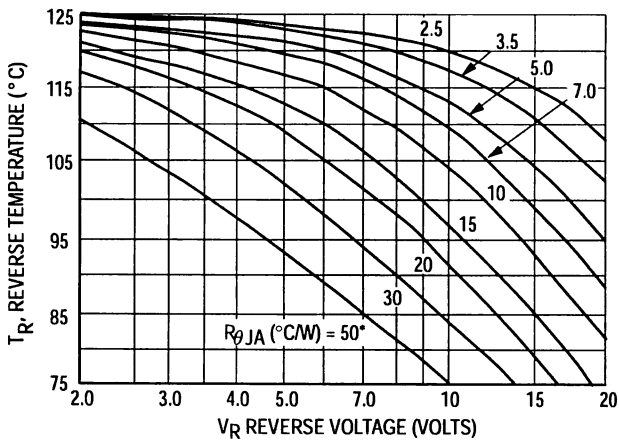


Figure 1. Maximum Reference Temperature – 1N5826

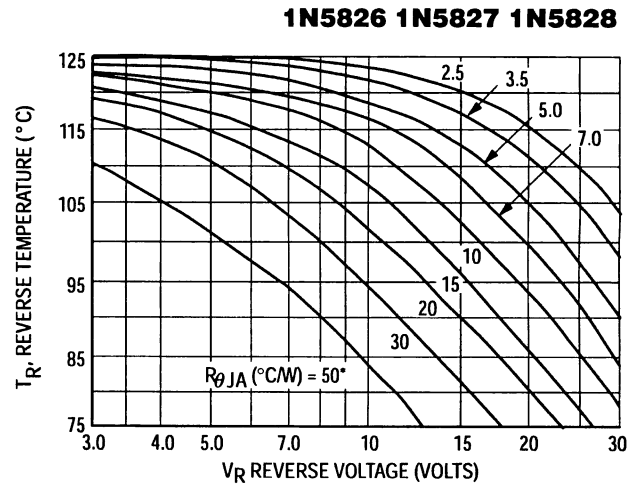


Figure 2. Maximum Reference Temperature – 1N5827

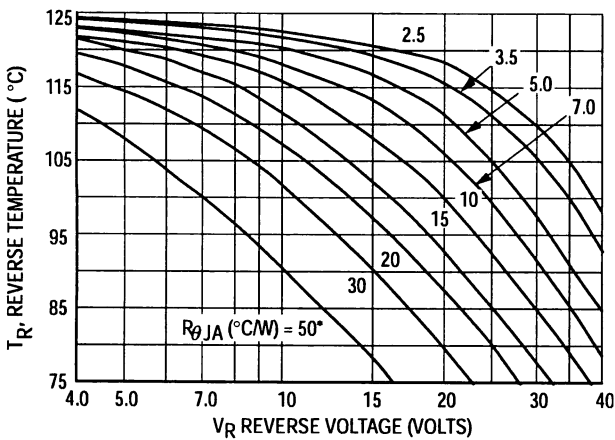


Figure 3. Maximum Reference Temperature – 1N5828

* NO EXTERNAL HEAT SINK

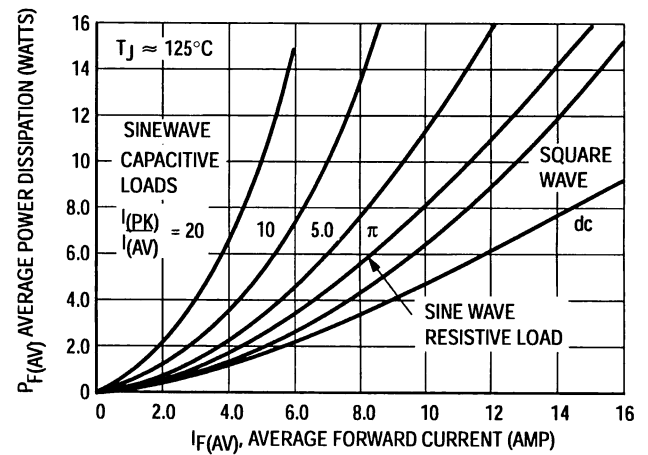


Figure 4. Forward Power Dissipation

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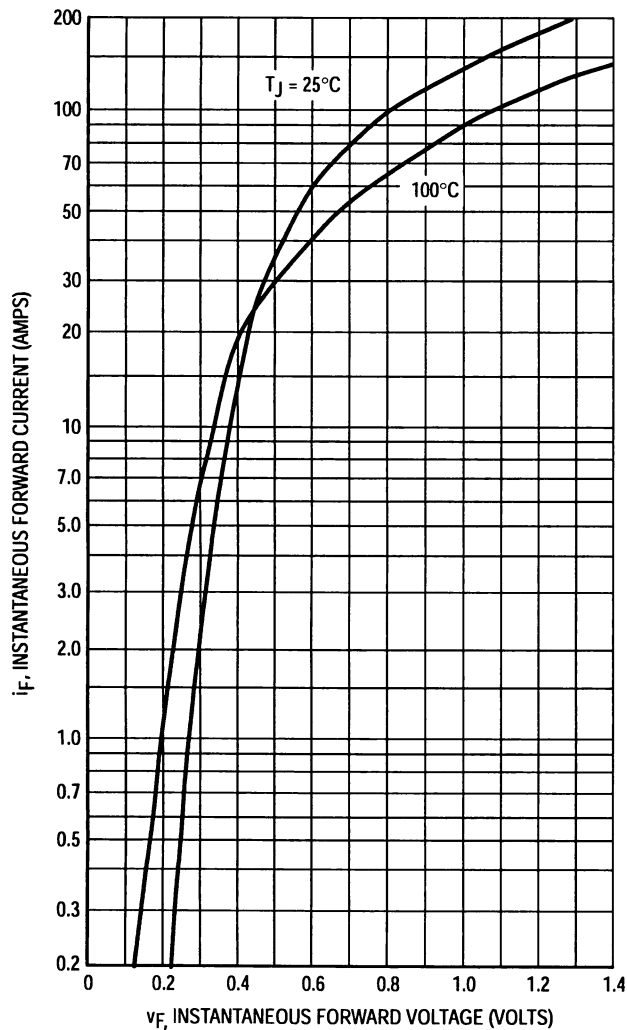


Figure 5. Typical Forward Voltage

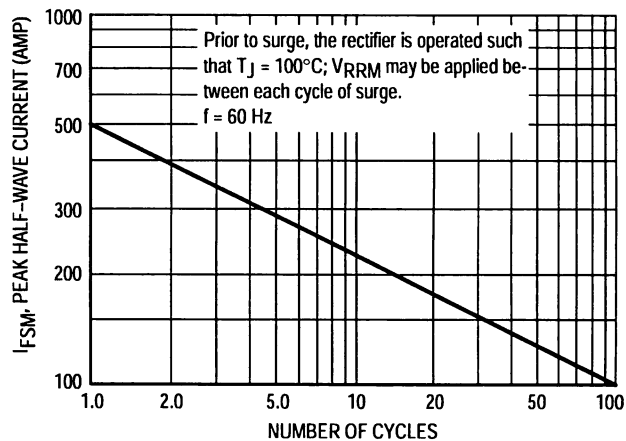


Figure 6. Maximum Surge Capability

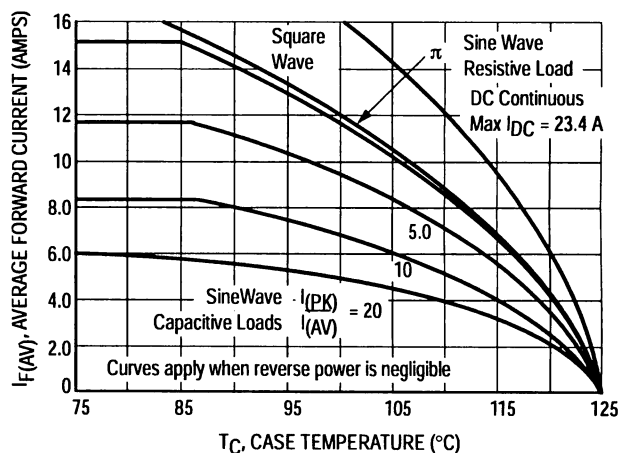


Figure 7. Current Derating

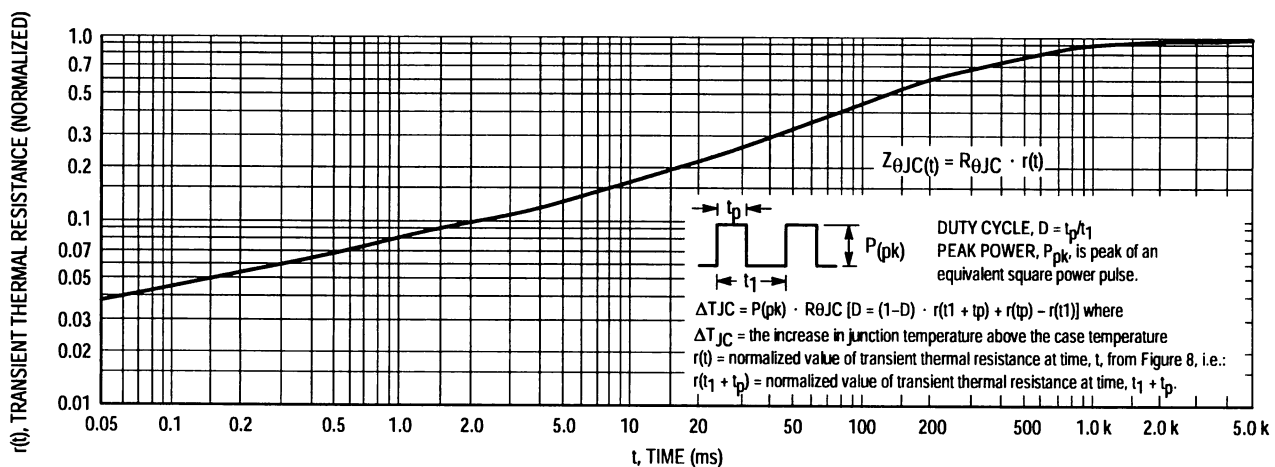


Figure 8. Thermal Response

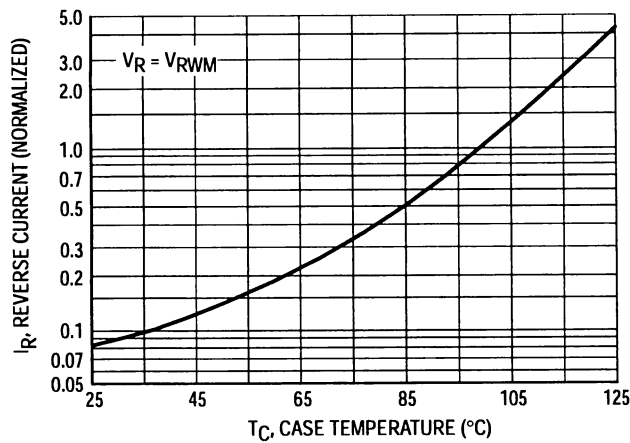


Figure 9. Normalized Reverse Current

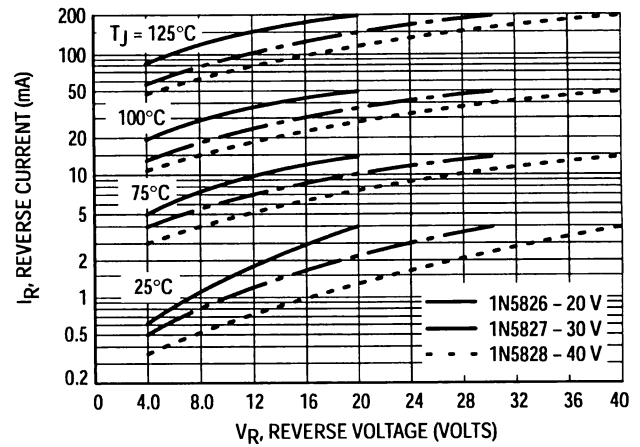


Figure 10. Typical Reverse Current

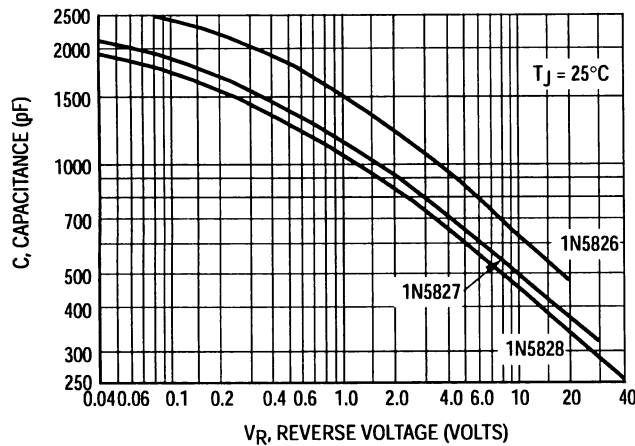


Figure 11. Capacitance

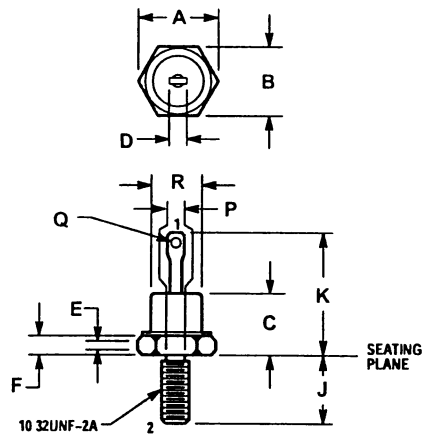
NOTE 2 — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 11.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

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PACKAGE DIMENSIONS



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	—	0.505	—	12.82
B	0.424	0.437	10.77	11.09
C	—	0.405	—	10.28
D	—	0.250	—	6.35
E	0.060	—	1.53	—
F	0.075	0.175	1.91	4.44
J	0.422	0.453	10.72	11.50
K	0.600	0.800	15.24	20.32
P	0.163	0.189	4.14	4.80
Q	0.060	0.095	1.53	2.41
R	0.265	0.424	6.74	10.76